

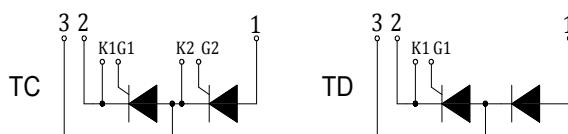
**Key Parameters**

$V_{RRM}$	1200~1400	V
$I_{T(AV)}$	1000	A
$I_{TSM}$	29	kA
$V_{TO}$	0.89	V
$r_T$	0.095	mΩ

**Applications**

- Various rectifiers
- DC supply for PWM inverter
- Industry converter

- 3000 V<sub>RMS</sub> isolating voltage with baseplate
- High power capability
- Industrial standard package

**Voltage Ratings**

Module Type	$V_{DRM}/V_{RRM}(V)$	Test Conditions
TMTC(TD) 1000	1200 1400	$T_{vj} = 25, 125^\circ C$ $I_{DRM} = I_{RRM} \leq 100$ mA $V_{DM} = V_{DRM}$ $V_{RM} = V_{RRM}$ $t_p = 10$ ms

$V_{DSM} = V_{DRM}$   
 $V_{RSM} = V_{RRM} + 100$

**Thermal & Mechanical Data**

Symb.	Parameter	Test Conditions	Min	Type	Max	Unit
$R_{th(j-c)}$	Thermal Resistance junction to case	sine.180°,per chip sine.180°,per module	-	-	0.04 0.02	°C / W
$R_{th(c-h)}$	Thermal resistance Case to heatsink,whole Module	Mounting surface smooth flat and greased per module	-	-	0.016	°C / W
$T_{vj}$	Maximum junction temperature		-40	-	125	°C
$T_{stg}$	Storage temperature		-40	-	100	°C
$F$	Busbar to module M12 Module to heatsink M8	Mounting torque ± 10 %	-	18 9	-	N·m N·m
$W$	Weight		-	3.3	-	kg

**Current Ratings**

Symb.	Parameter	Test Conditions	Min	Type	Max	Unit
$I_{T(AV)}$	Mean on-state current	Half Sine Wave, $T_c=80^\circ C$ Half Sine Wave, $T_c=85^\circ C$	-	-	1000 907	A
$I_{T(RMS)}$	RMS on-state current	$T_c = 80^\circ C$	-	-	1570	A
$I_{TSM}$	Surge on-state current	$t_p=10ms$ , Half Sine Wave, $T_{vj}=25^\circ C$ , $V_R = 0$	-	-	29.0	kA
$I^2t$	Limiting load integral	Sine Wave, $t_p=10ms$	-	-	421	$10^4 A^2s$

## Characteristics

Symb.	Parameter	Test Conditions	Min	Type	Max	Unit
$V_{TM}$	Peak on-state voltage	$T_{vj} = 25^\circ C, I_{TM} = 3000A$ $T_{vj} = 25^\circ C, I_{TM} = 1500 A$	-	-	1.3	V
$I_{DRM}$	Forward leakage current	$T_{vj} = 25^\circ C, 125^\circ C, V_{DRM}/V_{RRM}$	-	-	1.18	V
$I_{RRM}$	Reverse leakage current		-	-	100	mA
$V_{isol}$	Isolation voltage	a.c.; 50 Hz; r.m.s. ; $t=1min$ a.c.; 50 Hz; r.m.s. ; $t=1s$	-	3000 3600	- -	V
$V_{TO}$	Threshold voltage	$T_{vj} = 125^\circ C$	-	-	0.89	V
$r_T$	Slope resistance	$T_{vj} = 125^\circ C$	-	-	0.095	mΩ
$I_H$	Holding current	$T_{vj} = 25^\circ C$	-	-	200	mA
$I_L$	Latching current	$T_{vj} = 25^\circ C$	-	-	1000	mA

## Dynamic Parameters

Symb.	Parameter	Test Conditions	Min	Type	Max	Unit
$dv/dt$	Critical rate of rise of off-state voltage	$T_{vj} = 125^\circ C, \text{ Exp. to } 0.67 V_{DRM}$	1000	-	-	V/μs
$di/dt$	Critical rate of rise of on-state current	$T_{vj} = 125^\circ C, V_{DM} = 0.67 V_{DRM}, f = 50 \text{ Hz}$ $I_{TM} = 2000 A, I_{FG} = 2 A, t_r = 0.5 \mu s$	-	-	200	A/μs
$t_q$	Turn-off time	$T_{vj} = 125^\circ C, V_{DM} = 0.67 V_{DRM}, I_T = 2000 A$ $dv/dt = 20 V/\mu s, V_R = 200 V, -di/dt = 10 A/\mu s$	-	250	-	μs
$Q_{rr}$	Reverse Recovery Charge	$T_{vj} = 125^\circ C, -di/dt = 10 A/\mu s, I_T = 2000 A, V_R = 200 V$	-	3000	-	μC

## Gate Parameters

Symb.	Parameter	Test Conditions	Min	Type	Max	Unit
$I_{GT}$	Gate trigger current	$T_{vj} = 25^\circ C$	200	-	-	mA
$V_{GT}$	Gate trigger voltage	$T_{vj} = 25^\circ C$	3	-	-	V
$V_{GD}$	Gate non-trigger voltage	$T_{vj} = 125^\circ C, V_D = 0.4 V_{DRM}$	0.3	-	-	V
$V_{FGM}$	Peak forward gate voltage		-	-	12	V
$V_{RGM}$	Peak reverse gate voltage		-	-	5	V
$P_{GM}$	Gate peak power losses		-	-	20	W
$P_{G(AV)}$	Gate average power losses		-	-	4	W

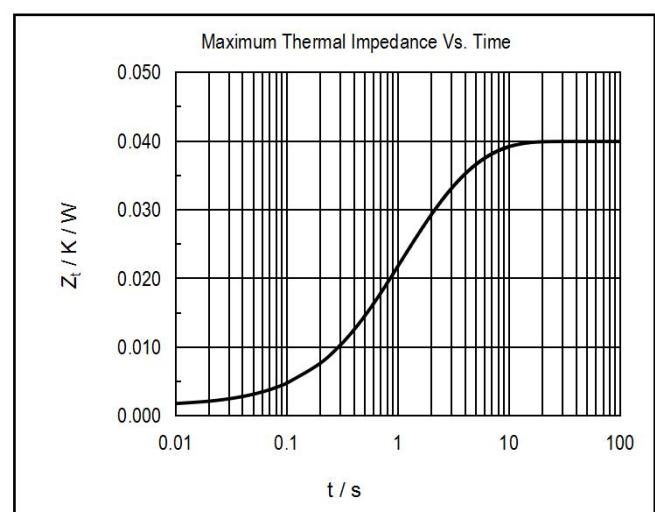
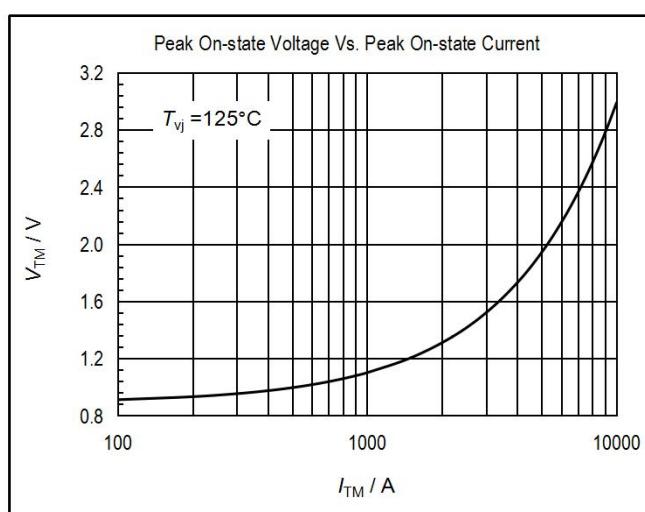


Fig1. Peak on-state Voltage Vs. Peak On-state Current

Fig2. Transient thermal Impedance Vs. Time

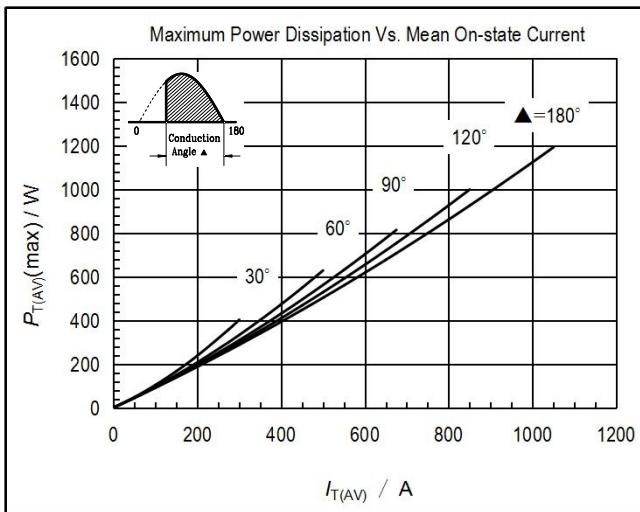


Fig3. Maximum Power Dissipation Vs. Mean On-state Current

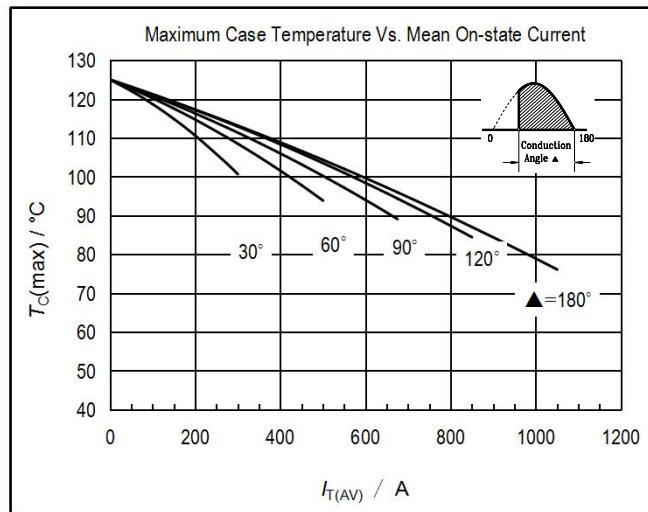


Fig4. Maximum Case Temperature Vs. Mean On-state Current

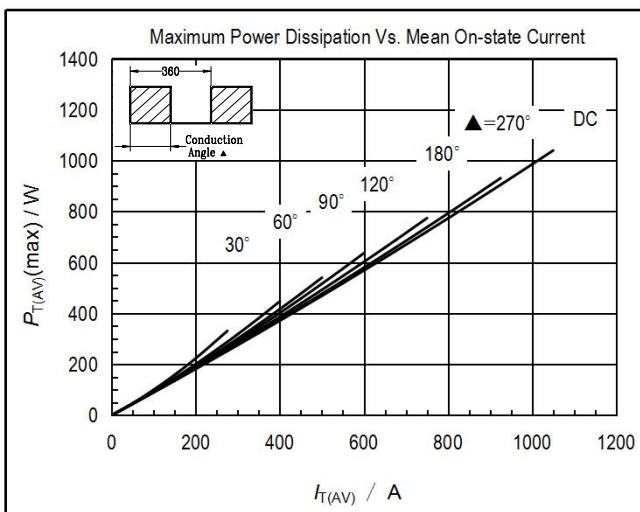


Fig5. Maximum Power Dissipation Vs. Mean On-state Current

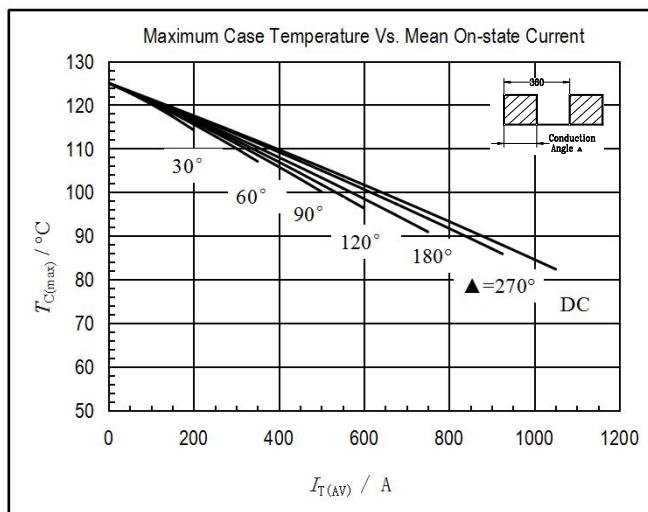
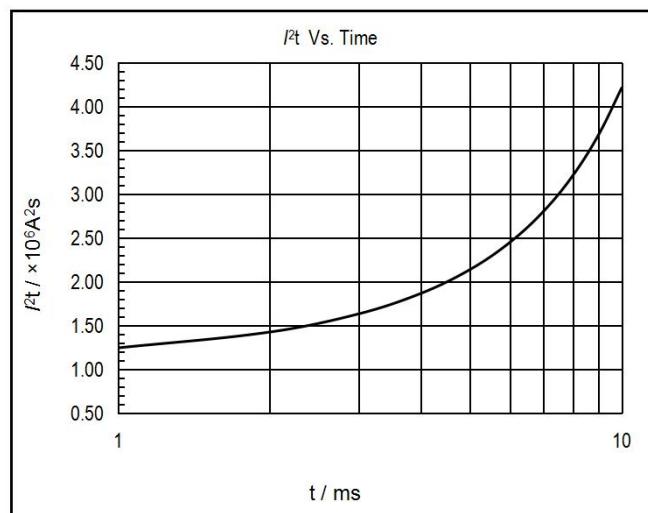
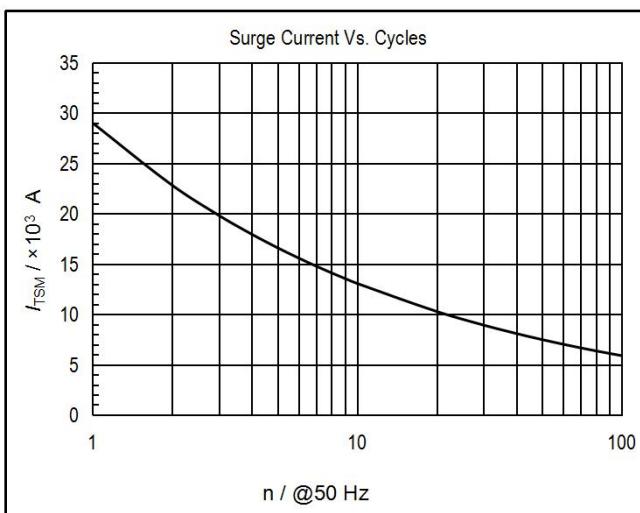


Fig6. Maximum Case Temperature Vs. Mean On-state Current



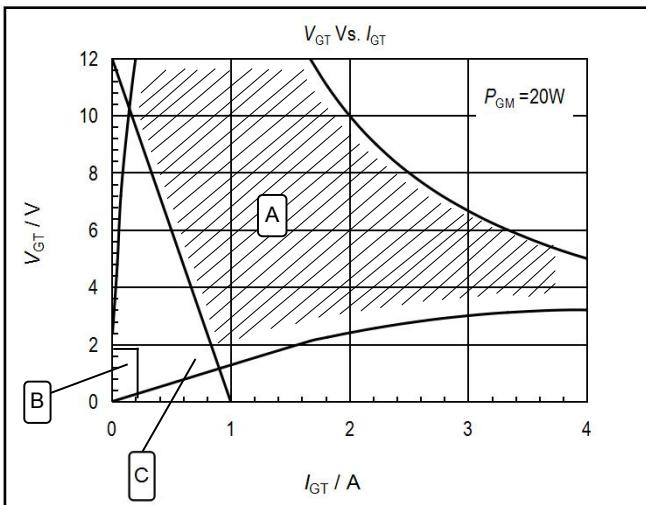


Fig9.  $V_{GT}$  Vs.  $I_{GT}$

A 为可靠触发区.  
B 为不可靠触发区.  
C 为建议采用的门极负载线.

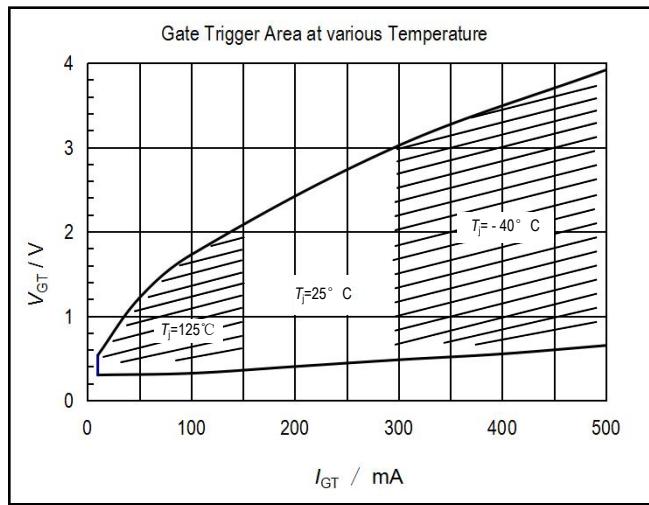


Fig10. Gate Trigger Area at various Temperature

A is Recommended Triggering Area.  
B is Unreliable Triggering Area.  
C is Recommended Gate Load Line.

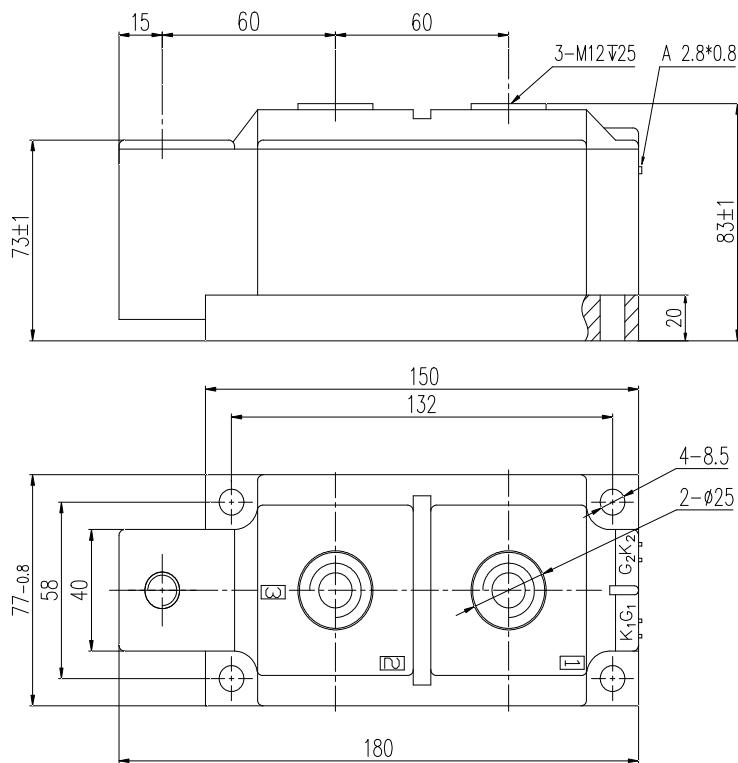


Fig9. Outline

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